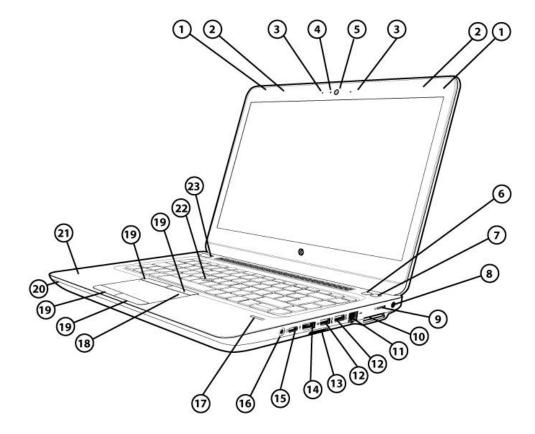
Overview

HP ProBook 645 G2 Notebook PC



- 1. WLAN antennas (2)
- 2. WWAN antennas (2) (select models)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. Power connector
- 9. SIM card slot
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.0 ports (2)

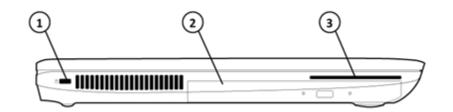
Front/Right

- 13. SD card slot
- 14. Display Port
- 15. USB-C port
- 16. Microphone/ headphones combo jack
- 17. Fingerprint reader (select models)
- 18. Touchpad
- 19. Touchpad buttons (4)
- 20. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 21. NFC (select models)
- 22. Pointstick (select models)
- 23. Power button

Note: The antennas are not visible from the outside of the computer. For optimal transmission, keep the areas immediately around the antennas free from obstructions. Models without optional webcam have single integrated microphone on left side of display panel.



Overview

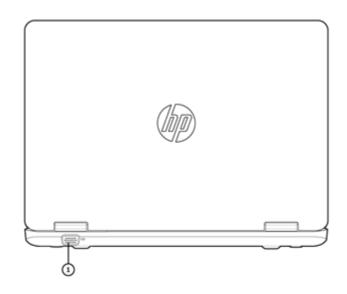


Left

1. Security lock slot

3. Smart Card Reader

2. Optical drive



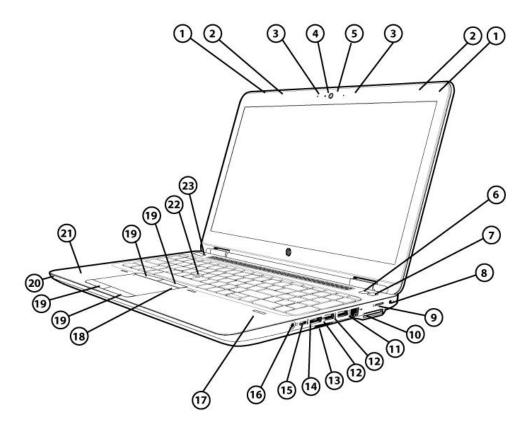
1. VGA port





Overview

HP ProBook 655 G2 Notebook PC



- 1. WLAN antennas (2)
- 2. WWAN antennas (2) (select models)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. Power
- connector
- 9. SIM card slot
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.0 ports (2)

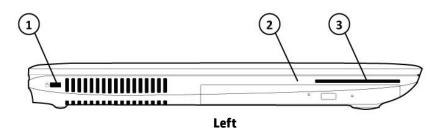
Front/Right

- 13. SD card slot
- 14. Display Port
- 15. USB-C port
- 16. Microphone/ headphones combo jack
- 17. Fingerprint reader (select models)
- 18. Touchpad
- 19. Touchpad buttons (4)
- 20. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 21. NFC (select models)
- 22. Pointstick (select models)
- 23. Power button
- Note: The antennas are not visible from the outside of the computer. For optimal transmission, keep the areas immediately around the antennas free from obstructions.

Models without optional webcam have single integrated microphone on left side of display panel.

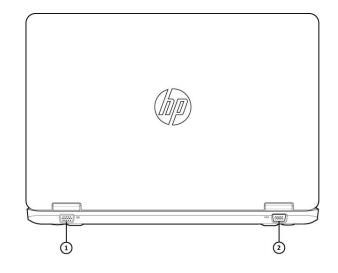


Overview



3.

- 1. Security lock slot
- 2. Optical drive



1. VGA port



Smart card reader



Overview

AT A GLANCE

- Windows 10 versions, Windows 8.1 versions, Windows 7 versions, Ubuntu Linux , Ubuntu Kylin Linux or FreeDOS 2.0
- Thin and light design— PC-ABS (Polycarbonate—AcryInitrile/Butadiene/Styrene) durable material is nearly 20% thinner; soft-touch, more durable 4-step paint process; larger buttons (power), revamped keyboard (arrow keys); latch/hook removal for clean palmrest design; top mounted speakers for optimized audio experience (compared to previous generation)
- The HP Premium keyboard is spill-resistant and offered with optional backlit design.
- Large Touchpad with gestures support, on/off button with LED indicator
- Enhanced security features including HP Fingerprint Reader and TPM 1.2 Embedded Security Chip
- Accelerated Processing Unit and graphics from AMD
- LED-backlit display
 - HP ProBook 645: 14.0" diagonal HD or FHD or Touch FHD with camera and with WWAN
 - HP ProBook 655: 15.6" diagonal HD or FHD or Touch FHD with camera and with WWAN
- Optional HD webcam with dual-microphone array for video conferencing
- DisplayPort 1.2 now native with integrated graphics
- One USB-C[™] Charging Port, two USB 3.0 ports for fast data transfer from devices (1 charging)
- HD Audio with DTS Sound+™ optimized for high fidelity audio
- Wireless and speaker mute button to conveniently manage the connectivity and speaker.
- Flexible wireless connectivity options:
 - Broadband Wireless (WWAN)
 - Wireless LAN (WLAN)
 - Personal area network (WPAN Bluetooth®)
 - Near Field Communication (NFC)
- Choice of hard drives up to 1 TB or solid state drives up to 512 GB
- Passed MIL STD testing¹

1. MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Summary of Changes

PRODUCT NAMES

HP ProBook 645 G2 Notebook PC

HP ProBook 655 G2 Notebook PC

OPERATING SYSTEM

Preinstalled	Windows 10 Pro 64 ¹ Windows 10 Home 64 ¹ Windows 10 Home Single Language 64 ¹ Windows 8.1 Pro 64 ³ Windows 8.1 64 ³
	Windows 7 Professional 32 (available through downgrade rights from Windows 10 Pro 64) ² Windows 7 Professional 32 (Available through downgrade rights from Windows 10 Pro 64) (National Academic only) ² Windows 7 Professional 64 ³ Windows 7 Professional 32 ³
	Windows 7 Professional 32 (National Academic only) ³ FreeDOS 2.0
Web-only Support	Windows 10 Enterprise 64 ¹ Windows 8.1 Enterprise 64 ³ Windows 7 Enterprise 64 ³ Windows 7 Enterprise 32 ³

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.
- 2. This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data
- 3. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. See http://www.microsoft.com.

ACCELERATED PROCESSING UNIT

AMD PRO A10-8700B APU with Radeon[™] R6 Graphics (1.8 GHz, up to 3.2 GHz, 2 MB cache, 4 cores)¹ AMD PRO A8-8600B APU with Radeon[™] R6 Graphics (1.6 GHz, up to 3 GHz, 2 MB cache, 4 cores)¹ AMD PRO A6-8500B APU with Radeon[™] R5 Graphics (1.6 GHz, up to 3 GHz, 2 MB cache, 2 cores)¹

1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

FUSION CONTROLLER HUB (FCH)



Summary of Changes

Chipset is integrated with processor

GRAPHICS

Radeon[™] R5 Graphics Radeon[™] R6 Graphics

NOTE: Integrated with processors. Please see processor section for details.

DISPLAY

HP ProBook 645 Internal

Non-Touch

14.0" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768)

14.0" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768) with camera

14.0" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768) with WWAN

14.0" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768) with camera and with WWAN

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080)

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with camera

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with WWAN

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with camera & WWAN **Touch**

14.0" diagonal LED backlight FHD 60% CG 300 nits (1920x1080) with camera and with WWAN

External

Up to 32-bit per pixel color depth VGA Port supports resolutions up to 1920 x 1200 external resolution @60 Hz DisplayPort 1.2

Supports resolutions up to 2560 x 1600, 30-bit color depth @60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth @ 120 Hz

Number of Displays Supported

HP Ultra Slim Docking	UMA Graphics
ProBook 645 with A10	3

HP ProBook 655 Internal

Non-Touch

15.6" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768)

15.6" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768) with camera

15.6" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768) with WWAN

15.6" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366x768) with camera and with WWAN

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080)

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with camera

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with WWAN

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with camera & WWAN



Summary of Changes

Touch

15.6" diagonal LED backlight FHD 60% CG 300 nits (1920 x 1080) with camera with WWAN

External

Up to 32-bit per pixel color depth VGA Port supports resolutions up to 1920 x 1200 external resolution @60 Hz DisplayPort 1.2 Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at 120 Hz Number of Displays Supported

HP Ultra Slim Docking	UMA
ProBook 655 with A10	3

1. HD content required to view HD images.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

500 GB 7200rpm Self	Drive Weight	0.21 lbs (95 g)	
Encrypting Drive (FIPS-	Capacity	500 GB	
140-2) (Opal 2)	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600 MB/s
	Seek Time	Single Track	1.5 ms
	(typical reads, including	Average	12ms
	settling)	Maximum	18mm-22ms
	Cache	32GB	
	Rotational Speed	7200 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C)	top cover temp]
	Features	ATA Security; TCG Opal 2.x	, FIPS, S.M.A.R.T., NCQ, Ultra DMA ,
500 GB 7200rpm	Drive Weight	0.20 lbs (92 g)-0.21 lbs (9!	5 g)
Hard Drive	Capacity	500 GB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600 MB/s
		Single Track	1.5ms-2.0ms



Summary of Changes

	Seek Time	Average	11ms-13ms
	(typical reads, including	Maximum	18ms-22ms
	settling)		
	Cache	32GB	
	Rotational Speed	7200 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	
500 GB 7200rpm Self-	Drive Weight	0.21 lbs (95 g)	
Encrypting Drive (Opal 2)		500GB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600 MB/s
	Seek Time	Single Track	1.5ms
	(typical reads, including	Average	12ms
	settling)	Maximum	18ms- 22ms
	Cache	32GB	
	Rotational Speed	7200rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
	Features	ATA Security; TCG Opal 2.x	, S.M.A.R.T., NCQ, Ultra DMA
1 TB 5400rpm Hard Drive	Drive Weight	0.21 lbs (94 g)- 0.21 lbs (9	۹ م)
i ib stoorphi hara brive	Capacity	1TB	5 9)
	Height	0.28 in (7.2 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600 MB/s
	Seek Time	Single Track	2ms
	(typical reads, including	Average	12ms-13ms
	settling)	Maximum	18ms-23ms
	Cache	Up to 32GB	
	Rotational Speed	5400rpm	
	Logical Blocks	1,953,525,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	S.M.A.R.T., NCQ, Ultra DMA	
	Drive Weight		
500 GB Hybrid, 8 GB cache	Drive Weight Capacity	0.21 lb (95 g)	
	Capacity Height	500 GB	
	Height	0.276 in (7 mm)	



	Width	2.76 in (70.1 mm)		
	Interface			
		ATA-8, SATA 2.6, 6.0 Gb/s,		
	Transfer Rate	Synchronous (maximum)		(Drive Capability)
	Seek Time (typical reads, including	Single Track	2 ms	
	settling)	Average	12 ms	
	-	Maximum	NIL ms	
	Cache	64GB		
	Rotational Speed	5400 rpm		
	Logical Blocks	976,773,168		
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security		
128 GB M2 2280 SATA-3	Drive Weight	0.019 lb (8.5 g)-0.022 lb (1	0 g)	
TLC Calid State Drive	Capacity	128 GB		
Solid State Drive	Height	0.09 in (2.23 mm)- 0.14 in	(3.58 mm)	
	Width	0.87 in (22 mm)		
	Interface	ATA-8, SATA 3.0		
	Performance	Maximum Sequential Rea	d	Maximum Sequential Write
		Up to 540 MB/s		Up to 300 MB/s
	Logical Blocks	250,069,680		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		mp]
	Features	ATA Security, DIPM; TRIM; I	DEVSLP	
180 GB M2 2280 SATA-3	Drive Weight	0.022 lb (<10 g)		
MLC	Capacity	180 GB		
Solid State Drive	Height	0.09 in (2.23 mm)		
	Width	0.87 in (22 mm)		
	Interface	ATA-8, SATA 3.0		
	Performance	Maximum Sequential Rea	d	Maximum Sequential Write
		Up to 540 MB/s (Compress Performance)	ible	UP to 490 MB/s (Compressible Performance)
	Logical Blocks	351,651,888		
	Operating Temperature	32° to 158°F (0° to 70°C) [a	imbient tei	mp]
	Features	ATA Security, DIPM; TRIM; I		
180 GB M2 2280 SATA-3	Drive Weight	0.022 lb (<10 g)		
Self-Encrypting Drive	Capacity	180GB		
(Opal 2) MLC Solid State	Height	0.09 in (2.23 mm)		
Drive	Width	0.87 in (22 mm)		
	Interface	ATA-8, SATA 3.0		
	Performance	Maximum Sequential Read	Maximum	Sequential Write



		Up to 540 MB/s	UP to 490 MB/s (Compressible Performance)
		(Compressible Performance)	
	Logical Blocks	351,651,888	
	Operating Temperature	32° to 158°F (0° to 70°C) [a	ambient temp]
	Features	ATA Security, TCG OPAL 2.3	• -
		ATA Security, red of he z.	
240 GB SATA-3 MLC Solid	Drive Weight	0.02 lb (10 g)	
State Drive	Capacity	240 GB	
	Height	0.14 in (3.58 mm)	
	Width	0.87 in (22 mm)	
	Interface	ACS-3, SATA 3.2	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 540 MB/s	UP to 490 MB/s
	Logical Blocks	468,862,128	
	Operating Temperature	32° to 158°F (0° to 70°C) [a	ambient temp]
	Features	ATA Security, DIPM; TRIM;	DEVSLP
256 GB 2280 SATA-3 TLC	Drive Weight	0.019 lb (8.5 g)- 0.022 lb (10 g)
Solid State Drive	Capacity	256GB	
	Height	0.09 in (2.3 mm)- 0.14 in (3.58 mm)
	Width	0.87 in (22 mm)	
	Interface	ATA-8, SATA 3.0	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Read Up to 540 MB/s	Maximum Sequential Write Up to 455 MB/s
	Logical Blocks	Read Up to 540 MB/s 500,118,192	Up to 455 MB/s
	Logical Blocks Operating Temperature	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a	Up to 455 MB/s ambient temp]
	Logical Blocks	Read Up to 540 MB/s 500,118,192	Up to 455 MB/s ambient temp]
256 GB PCIe-3x4 NVMe	Logical Blocks Operating Temperature	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a	Up to 455 MB/s ambient temp]
256 GB PCIe-3x4 NVMe Solid State Drive	Logical Blocks Operating Temperature Features	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM;	Up to 455 MB/s ambient temp]
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm)	Up to 455 MB/s ambient temp]
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm)	Up to 455 MB/s ambient temp]
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4	Up to 455 MB/s ambient temp] DEVSLP
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm)	Up to 455 MB/s ambient temp]
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential	Up to 455 MB/s ambient temp] DEVSLP
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential Read Up to 2,260 MB/s 500,118,192	Up to 455 MB/s ambient temp] DEVSLP Maximum Sequential Write UP to 1,260 MB/s
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance Logical Blocks Operating Temperature	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential Read Up to 2,260 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a	Up to 455 MB/s ambient temp] DEVSLP Maximum Sequential Write UP to 1,260 MB/s
	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential Read Up to 2,260 MB/s 500,118,192	Up to 455 MB/s ambient temp] DEVSLP Maximum Sequential Write UP to 1,260 MB/s
Solid State Drive 256 GB M2 2280 SATA-3	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance Logical Blocks Operating Temperature Features	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential Read Up to 2,260 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, TRIM; L1.2 0.02 lb (10 g)	Up to 455 MB/s ambient temp] DEVSLP Maximum Sequential Write UP to 1,260 MB/s
Solid State Drive	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance Logical Blocks Operating Temperature Features	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential Read Up to 2,260 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, TRIM; L1.2 0.02 lb (10 g) 256 GB	Up to 455 MB/s ambient temp] DEVSLP Maximum Sequential Write UP to 1,260 MB/s ambient temp]
Solid State Drive 256 GB M2 2280 SATA-3	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance Logical Blocks Operating Temperature Features	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential Read Up to 2,260 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, TRIM; L1.2 0.02 lb (10 g) 256 GB 0.14 in (3.58 mm)- 0.09 in	Up to 455 MB/s ambient temp] DEVSLP Maximum Sequential Write UP to 1,260 MB/s ambient temp]
Solid State Drive 256 GB M2 2280 SATA-3	Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Performance Logical Blocks Operating Temperature Features	Read Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM; 0.02 lb (10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3X4 Maximum Sequential Read Up to 2,260 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security, TRIM; L1.2 0.02 lb (10 g) 256 GB	Up to 455 MB/s ambient temp] DEVSLP Maximum Sequential Write UP to 1,260 MB/s ambient temp]



Summary of Changes

(Opal 2) MLC Solid State Drive	Interface Performance	ATA-8, SATA 3.0 Maximum Sequential Read	Maximum Sequential Write
	Logical Blocks Operating Temperature Features	Up to 540 MB/s 500,118,192 32° to 158°F (0° to 70°C) [a ATA Security; TCG Opal 2.0	-
512 GB M2 2280 TLC Solid State Drive	Drive Weight Capacity Height Width Interface Performance	0.019 lb (8.5 g)- 0.02 lb (1 512 GB 0.09 in (2.3 mm) 0.87 in (22 mm) ATA-8, SATA 3.0 Maximum Sequential	0 g) Maximum Sequential Write
	Performance Logical Blocks Operating Temperature Features	Maximum Sequentiat Read Up to 540 MB/s 1,000,215,216 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM;	UP to 500 MB/s ambient temp]
512 GB M2 2280 SATA-: Self-Encrypting Drive (Opal 2) MLC Solid State Drive	Capacity Height Width Interface	0.019 lb (8.5 g)- 0.02 lb (1 512 GB 0.09 in (2.3 mm) 0.87 in (22 mm) ATA-8, SATA 3.0	
	Performance Logical Blocks Operating Temperature Features	Maximum Sequential Read Up to 540 MB/s 1,000,215,216 32° to 158°F (0° to 70°C) [a ATA Security, DIPM; TRIM;	•

OPTICAL DRIVES

Fixed 9.5 mm SATA DVD-ROM Drive DVD+/-RW SuperMulti DL¹ Blu-ray ROM DVD+/-RW SuperMulti DL¹ Weight saver²

1. For Blu-ray drives, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require an HDMI digital connection and your display may require HDCP support. HD-DVD disks cannot be played on this drive. Note that DVD-RAM cannot read or write to 2.6 GB Single Sided/5.2 GB Double Sided – Version 1.0 media. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs; discs burned with this drive may not be compatible with many existing single-layer DVD drives and



Summary of Changes

players. 2. Not available on with Touch panel.

MEMORY

Standard

DDR3L PC3-12800 (Transfer rates up to 1600 MT/s) Two SODIMM slots supporting dual-channel memory

4096 MB Total System Memory (4096 MB x 1) 8192 MB Total System Memory (4096 MB x 2) 8192 MB Total System Memory (8192 MB x 1) 16384 MB Total System Memory (8192 MB x 2)

Maximum

Up to 16384 MB with optional 8192 MB SODIMMs in slots 1 and 2

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Broadband Wireless (WWAN)^{2,3}

HP lt4120 Qualcomm[®] Snapdragon™ X5 LTE Mobile Broadband Module HP hs3110 HSPA+ Mobile Broadband Module

Wireless LAN (WLAN)^{1,2}

Options via Minicard Intel® 802.11a/b/g/n/ac (2x2) and Bluetooth® 4.0 Combo Intel® 802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo Broadcom 802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo Realtek 802.11b/g/n (1x1) Wi-Fi

Personal area network (WPAN Bluetooth)^{1,2}

Bluetooth[®] 4.0 supported via all combo cards (Except for Intel[®] 802.11 ac and Intel[®] 802.11 a/b/g/Non-vPro) Bluetooth[®] 4.1 supported via Intel[®] 802.11 ac and Intel[®] 802.11 a/b/g/n Non-vPro only

Near Field Communication (NFC) Optional²

HP Module with NXP NFC Controller NPC100

Support for Miracast (Windows 8.1 and Windows 10)

1. Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.

2. Sold separately or as an optional feature.



Summary of Changes

3. WWAN module is optional and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Communications

500 GB 7200 rpm Self Encrypting Drive (Opal 2) (FIPS)

1. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

HD Audio with DTS Sound+™ (2) Integrated stereo speakers Integrated digital microphone (Dual-microphone array when equipped with optional webcam) Function keys for microphone mute, volume up, volume down Stereo headphone/line out Stereo microphone in

Webcam

Optional 720p HD webcam ^{1,2}

- HD format (widescreen)
- Supports videoconferencing (non-HD) and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range
- Skype-ready
- 1. Sold separately or as an optional feature.
- 2. HD content required to view HD images.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

HP Advanced Keyboard

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard. The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys. DuraKeys only available with Backlit option.

Touchpad

On/Off button Enabled by default 2F Scrolling - On 2F Zoom (Pinch) - On OSD (enable / disable) - On Win 8 2F tap = right click - On



Win 8 Edge Swipes – On

Buttons and Function Keys

- F1 Sleep
- F2 Blank
- F3 Backlit
- F4 Display Switch
- F5 Brightness down
- F6 Brightness up
- F7 Blank
- F8 Volume down
- F9 Volume up
- F10 Mic Mute
- F11 Bank
- F12 Num lock

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System

BIOS

HP DriveLock | HP Automatic Drive Lock HP BIOS Protection¹ HP Disk Sanitizer² HP SpareKey³ Update via Network Master Record Security Power On Authentication Pre-Boot Security Secure Erase⁴ Hybrid Boot Measured Boot Secure Boot Absolute Persistence Module⁵

MultiMedia

CyberLink PowerDVD CyberLink Power2Go (Optical drives) CyberLink YouCam BE (Windows 7 only)

Communication

HP Connection Manager (Windows 7 only) HP GPS and Location⁶ (Windows 7 only) HP Mobile Connect⁷ (Windows 8 only) HP Wireless Hotspot⁸ (Windows 8 only) Intel WiDi Software⁹ HP Roaming Alert (Windows 8 only) Intel My WiFi and Wireless Drivers

HP Value Add Software HP 3D DriveGuard (requires Windows)



Summary of Changes

HP ePrint Driver¹⁰ (HP Exclusive) HP PageLift (HP Exclusive)¹¹ HP Recovery Manager (Windows 7 only) HP Support Assistant HP Recovery Disc Creator (Windows 7 only) UEFI System Diagnostics W8

3rd Party

Adobe Flash Player Skype¹² (subscription required and sold separately) Buy Office

Security Hardware

HP Client Security¹³ HP Credential Manager HP Password Manager HP Drive Encryption (FIPS 140-2)¹⁴ HP Device Access Manager with Just In Time Authentication HP File Sanitizer¹⁵ HP Spare Key Integrated Smart Card Reader (FIPS 201) Security screw for bottom access door Microsoft Security Essentials (Windows 7)¹⁶ Microsoft Defender (Windows 8) TPM 1.2/2.0¹⁷ HP Fingerprint reader Security lock slot Integrated Smart Card Reader

1. HP Tools partition with an HP BIOS required for automatic recovery.

For the use cases outlined in the DOD 5220.22-M Supplement. Does not support Solid State Drives (SSDs). Initial setup required. Web history deleted only in Internet Explorer and Firefox browsers and must be user enabled.
 Requires initial user set up.

4. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
5. The Absolute Persistence agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

6. GPS access requires an unobstructed path to multiple satellites. Performance may be affected if/when used inside of buildings, bridges or heavily congested metropolitan areas. Requires separately purchased GPS navigation software available from multiple GPS applications.

7. Internet access required.

8. The wireless hotspot application requires an active internet connection and separately purchased data plan. While HP wireless hotspot is active, on-device applications will continue to work and will use the same data plan as the wireless hotspot. Wireless hotspot data usage may incur additional charges. Check with your service provider for plan details. Requires Windows 8.1 or HP Connection Manager for Windows 7.

9. Integrated Intel Wi-Di feature is available on select configurations only and requires separately purchased projector, tv or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, tv or computer monitor via a standard HDMI cable, also sold separately.



Summary of Changes

10. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see

www.hp.com/go/eprintcenter).Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

11. HP PageLift requires Windows 7 or higher edition.

12. Skype is not offered in China.

13. Not all features are remotely manageable.

14.Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access. Drive encryption planned to be available in October 2013.

15. For the use cases outlined in the DOD 5220.22-M Supplement. Does not support Solid State Drives (SSDs). Initial setup required. Web history deleted only in Internet Explorer and Firefox browsers and must be user enabled.

16. Opt in and internet connection required for updates.

For more information on HP security solutions refer to: http://www.hp.com/go/security.

17. This product ships with TPM 1.2 with option to upgrade to TPM 2.0. Upgrade utility is expected to be available by the end of 2015 via HP Customer Support.

POWER

Power Supply

HP 45W Smart AC Adapter (UMA only) HP 65W Smart AC Adapter Power cord included is 1.8 m (+/- 0.1 m) or 1.0 m (+/- 0.1 m).

Primary Battery

HP 3-cell Long Life Prismatic (48 WHr)

Battery Life¹

HP ProBook 645 Notebook PC	UMA Graphics	Discrete Graphics
3-cell (48 Whr) with SSD	Up to 8 hrs 15 mins	N/A
3-cell (48 Whr) with HDD	Up to 7 hrs 15 mins	N/A
HP ProBook 655 Notebook PC	UMA Graphics	Discrete Graphics
3-cell (48 Whr) with SSD	Up to 8 hrs	N/A
3-cell (48 Whr) with HDD	Up to 7 hrs 15 mins	N/A

System Standby Time²

	UMA Graphics	Discrete Graphics
HP ProBook 640 Notebook PC	Up to 186 hrs	N/A
HP ProBook 650 Notebook PC	Up to 186 hrs	N/A



Battery recharge times

	ProBook 645 G2	ProBook 655 G2
Time to 90% Charge ³ (minutes)	109	109
Time to 100% Charge ⁴ (minutes)	167	167

1. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

2. Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

3. Recharges your battery up to 90% within 109 minutes when the system is off. Applies to 3-cell 48Whr battery only. When the PC is powered on, charge time may increase and will vary based on the workload of the notebook PC.

4. Recharges your battery up to 100% within 167 minutes when the system is off. Applies to 3-cell 48Whr battery only. When the PC is powered on, charge time may increase and will vary based on the workload of the notebook PC.

WEIGHTS & DIMENSIONS

HP ProBook 645 Notebook PC

Weight

Starting at 4.30 lbs (1.95 kg)¹ (3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)

Dimensions (w x d x h) 13.39 x 9.33 x 1.06 in (Front and rear)² 34.0 x 23.7 x 2.70 cm (Front and rear)

HP ProBook 655 Notebook PC

Weight

Starting at 5.1 lbs (2.31 kg)¹ (3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)

Dimensions (w x d x h) 14.88 x 10.11 x 1.07 in (Front and rear)² 37.8 x 25.7 x 2.74 cm (Front and rear)

1. Weight varies by configuration and components.

2. Height varies depending upon where on the notebook the measurement is made.

PORTS/SLOTS

Ports USB TypeC[™] - One



Summary of Changes

USB 3.0 port – One USB 3.0 port Charging – One RJ-45 / Ethernet - One Docking connector – One Headphone / Microphone (Combo jack) – One AC port (4.5mm) – One DisplayPort -One VGA port – One Serial port optional – One (HP ProBook 655 Notebook PC only) ¹

SD Media Reader Slot

Supports SD, SDHC, SDXC

1. Sold separately or as an optional feature.

SERVICE AND SUPPORT

Limited 3-year, 1-year or 90-day limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform.Optional¹ HP Care Pack Services² are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <u>http://www.hp.com/gp/cpc</u>.

1. Sold separately or as an optional feature.

2. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp



System Unit

TBD

DISPLAYS*

14.0 FHD AG WLED SVA 60%cg 300nits eDP Slim

Panel	
Active Area (W x H)	309.40 x 173.95 (mm)
Dimensions (W x H)	320.9 x 205.6 (mm) max
Diagonal Size	14 (inch)
Thickness	3.0 (mm) max
Weight	270 g max
Interface	eDP 1.2
Surface Treatment	Anti-Glare (AG)
Contrast Ratio	300:1 (typical)
Refresh Rate	60 Hz
Brightness	300 nits
Pixel Resolution - Format	1920 x 1080 (FHD)
РРІ	157
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	60%
Color Depth	6 bits
Viewing Angle	SVA 45/45/25/35

14.0 HD AG WLED SVA 45%cg 220nits eDP Flat



Panel	
Active Area (W x H)	309.40 x 173.95 (mm)
Dimensions (W x H)	320.9 x 205.6 (mm) max
Diagonal Size	14 (inch)
Thickness	3.6 (mm) max
Weight	320 g max
Interface	eDP 1.2
Surface Treatment	Anti-Glare (AG)
Contrast Ratio	300:1 (typical)
Refresh Rate	60 Hz
Brightness	220 nits
Pixel Resolution - Format	1280 x 768 (HD)
PPI	112
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	45%
Color Depth	6 bits + Hi FRC
Viewing Angle	SVA 45/45/25/35

14.0 FHD WLED SVA 60%cg 300nits eDP Slim touch

Panel	
Active Area (W x H)	309.40 x 173.95 (mm)
Dimensions (W x H)	320.9 x 205.6 (mm) max
Diagonal Size	14 (inch)



Thickness	3.0 (mm) max
Weight	270 g max
Interface	eDP 1.2
Contrast Ratio	300:1 (typical)
Refresh Rate	60 Hz
Brightness	300 nits
Pixel Resolution - Format	1920 x 1080 (FHD)
РРІ	157
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	60%
Color Depth	6 bits
Viewing Angle	SVA 45/45/25/35
Touch Enabled	Optional
Touch Point Supported	10-point multi-touch
Other Features	AS
Pen Enabled	Νο

15.6 FHD AG WLED SVA 60%cg 300nits eDP Slim 3.2mm

Panel	
Active Area (W x H)	344.2 x 193.5 (mm)
Dimensions (W x H)	360 x 224.3 (mm) max
Diagonal Size	15.6 (inch)
Thickness	3.2 (mm) max



360 g max
eDP 1.2
Anti-Glare (AG)
400:1 (typical)
60 Hz
300 nits
1920 x 1080 (FHD)
142
RGB
LED
60%
6 bits
SVA 45/45/25/35

15.6 HD AG WLED SVA 45%cg 220nits eDP Flat

344.2 x 193.5 (mm)
360 x 224.3 (mm) max
15.6 (inch)
3.8 (mm) max
420 g max
eDP 1.2
Anti-Glare (AG)
300:1 (typical)



Refresh Rate	60 Hz
Brightness	220 nits
Pixel Resolution - Format	1280 x 768 (HD)
PPI	101
Pixel Resolution - Configuration	RGB
Backlight	LED
Color Gamut Coverage	45%
Color Depth	6 bits + Hi FRC
Viewing Angle	SVA 45/45/25/35

15.6 FHD WLED SVA 60%cg 300nits eDP Slim 3.2mm touch

Panel		
Active Area (W x H)	344.2 x 193.5 (mm)	
Dimensions (W x H)	360 x 224.3 (mm) max	
Diagonal Size	15.6 (inch)	
Thickness	3.2 (mm) max	
Weight	360 g max	
Interface	eDP 1.2	
Contrast Ratio	400:1 (typical)	
Refresh Rate	60 Hz	
Brightness	300 nits	
Pixel Resolution - Format	1920 x 1080 (FHD)	
PPI	142	
Pixel Resolution - Configuration	RGB	



Backlight	LED
Color Gamut Coverage	60%
Color Depth	6 bits
Viewing Angle	SVA 45/45/25/35
Touch Enabled	Optional
Touch Point Supported	10-point multi-touch
Other Features	AS
Pen Enabled	No

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Networking/communications

Technology/Operating bands	HP lt4120 Qualcomm [®] Snapdragon [™] X5 LTE Mobile Broadband Module* LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 800 (Band 20), 700 (Band 28). HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz EV-D0: 850 (BC0), 1900 (BC1) MHz (Only work with Verizon network) E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8)
	MHz
Wireless protocol standards	3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification 1xEVDO Release 0, A and B. E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4 and MSC1 - MSC9
GPS	Standalone, A-GPS (MS-A, MS-B and XTRA)
GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
Maximum data rates	LTE: 150 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVD0 Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
Maximum output power	LTE: 23 dBm
	Not all configuration components are available in all regions/countries. Americas – HP ProBook 645 & 655 G2 – November 2016 - c04912055

	HSPA+: 23.5 dBm 1xRTT/EVDO: 24dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm
Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) 1xRTT/EVD0: 1,000 mA (peak); 700 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	6.2 g
Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

	HP hs3110 HSPA+ Intel® Mobile Broadband Module*
Technology/Operating bands	HSPA+: 2100 (Band1), 1900 (Band 2), 1700 (Band 4), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz
Wireless protocol standards	WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9
GPS	Standalone, A-GPS
GPS bands	1575.42 MHz ± 1.023 MHz
Maximum data rates	HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)
	E-GPRS: 296 kbps (Download), 236.8 kbps (Upload) GPRS: 107 kbps (Download), 85.6 kbps (Upload)
Maximum output power	HSPA+: 24 dBm E-GPRS 1800/1900: 26 dBm E-GPRS 850/900: 27 dBm GPRS 1800/1900: 30 dBm GPRS 850/900: 33 dBm
Maximum power consumption	HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,800 mA (peak); 700 mA (average)
Form Factor	М.2, 3042-S3 Кеу В
Weight	6 g
Dimensions (Length x Width x Thickness)	1.65 x 1.18 x 0.09 in (42 x 30 x 2.3 mm)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.



Intel® 802.11a/b/g/n/ac (2x2) and Bluetooth® 4.1 Combo

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz Note:
	The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
	802.11a/n
	 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz Note: Indonesia no support this band)
Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication

• 802.1x authentication



	 WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i 	
	Cisco Certified Extensions, all versions through CCX4 and CCX Lite	
	• WAPI	
Network Architecture	Ad-hoc (Peer to Peer)	
Models	Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power ²	• 802.11b : +16dBm minimum	
	• 802.11g : +14dBm minimum	
	• 802.11a : +14dBm minimum	
	• 802.11n HT20(2.4GHz) : +14dBm minimum	
	• 802.11n HT40(2.4GHz) : +12dBm minimum	
	 802.11n HT20(5GHz) : +14dBm minimum 	
	 802.11n HT40(5GHz) : +12dBm minimum 	
Power Consumption	Transmit: 2.0 W (max)	
	Receive: 1.6 W (max)	
	Idle mode (PSP): 180 mW (WLAN Associated)	
	Idle mode: 50 mW (WLAN unassociated)	
	Connect Standby: 10 mW (WLAN+BT)	
	Radio disabled: 5 mW	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum	
	802.11b, 11Mbps : -86dBm maximum	
	802.11g, 6Mbps : -88dBm maximum	
	802.11g, 54Mbps : -74dBm maximum	
	802.11a, 6Mbps : -88dBm maximum	
	802.11a, 54Mbps : -74dBm maximum	
	802.11n, MCS07 : -69dBm maximum	



Summary of Changes

	802.11n, MCS15 : -66dBm maximum		
	802.11ac, 1SS, MCS-0 : -86dBm maximum		
	802.11ac, 1SS, MCS-9 : -61dBm maximum		
	802.11ac, 2SS, MCS-0 : -83dBm maximum		
	802.11ac, 2SS, MCS-9 : -58dBm maximum		
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure		
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm		
	Or Type 1630 : 2.3 x 16.0 x 30.0 mm		
Weight	Type 2230 : 2.8g		
	Or		
	Туре 1630 : 2g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber – Radio OFF; LED White – Radio ON		

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology



Summary of Changes

Bluetooth Specification	4.0/4.1/4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH)
	BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps
	Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity	Modulation	0.01% BER	0.001% BER
Legacy	GFSK	-80 dBm	-70 dBm
	π/4-DQPSK	-80 dBm	-70 dBm
	8DPSK	-80 dBm	-70 dBm
Power Consumption	Peak (Tx) 330 mW		
-	Peak (Rx) 230 mW		
	Selective Suspend 1	7 mW	
Range	Legacy Up to 33 ft (10 m)	
	BLE Up to 99 ft (30 r	n)	
Electrical Interface	USB 2.0 compliant		
Bluetooth Software Supported	Microsoft Windows Bluetooth Software		
Link Topology			
Electrical Interface	Point to Point, Multipoint Pico Nets up to 7 slaves		
Bluetooth Software Supported	Full support of Bluetooth Security Provisions		



Summary of Changes

Security	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Security	All necessary regulatory approvals for supported countries, including:
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Bluetooth Profiles Supported	
Power Management	ETS 300 328, ETS 300 826
Certifications	Low Voltage Directive IEC950
	UL, CSA, and CE Mark
Certifications Bluetooth Profiles Supported	Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) Audio Video Remote Control Profile (AVRCP)
Bluetooth V4.1/V4.2 support feature	V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Intel® 802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo



Summary of Changes

Wireless LAN	IEEE 802.11a
Standards	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz Note:
	The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
	802.11a
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz
	• 5.47 – 5.725 GHz
	• 5.825 – 5.850 GHz
	Note:
	Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)
Antenna Structure	2 transmit; 2 receive (2x2)
Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	802.11b: 1, 2, 5.5, 11 Mbps
	802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
Modulation	Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g
	mode only
	AES-CCMP: 128 bit in hardware
	802.1x authentication WDA WDA2: 802.1x WDA DSK WDA2 DSK TKID and ASS
	• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.



Summary of Changes

Sub-channels Network Architecture	 WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI Multinational support with frequency bands and channels compliant to local regulations.
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between band Access Points
Output Power ² Power Consumption	 802.11b: +16dBm minimum 802.11g: +14dBm minimum 802.11a: +14dBm minimum 802.11a: +14dBm minimum 802.11n HT20(2.4GHz): +13dBm minimum 802.11n HT40(2.4GHz): +12dBm minimum 802.11n HT40(5GHz): +12dBm minimum 800 HT40(100000000000000000000000000000000000
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³ Antenna type	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -86dBm maximum 802.11a, 54Mbps : -72dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card
	to support WLAN MIMO and Bluetooth communications



Summary of Changes

Form Factor	PCI-Express M.2 MiniCard	
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm	
	Or Type 1630 : 2.3 x 16.0 x 30.0 mm	
Weight	Туре 2230 : 2.8g	
	Or	
	Туре 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non- condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber - Radio OFF; LED White - Radio ON	

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification	4.0+EDR Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	79 (1 MHz) available channels	
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps	
	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels	



Summary of Changes

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric

Transmit PowerThe Bluetooth component shall operate as a Class II Bluetooth device
with a maximum transmit power of +4 dBm for BR and EDR.

		•	
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER
	GFSK	-80 dBm	-70 dBm
	π/4-DQPSK	-80 dBm	-70 dBm
	8DPSK	-80 dBm	-70 dBm
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1	7 mW	
Range	Up to 33 ft (10 m)		
Electrical Interface	USB 2.0 compliant		
Bluetooth Software Supported	Microsoft Windows Bluetooth Software		
Link Topology			
Electrical Interface	Point to Point, Multi	point Pico Nets u	p to 7 slaves
Bluetooth Software Supported	Full support of Bluetooth Security Provisions		
Security			
Power Management	Microsoft Windows	ACPI, and USB Bu	s Support
Power Management	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff		
Certifications			and Shift
Security	All necessary regula	itory approvals fo	or supported countries, including:
Certifications	FCC (47 CFR) Part 15	5C, Section 15.247	7 & 15.249
Bluetooth Profiles Supported			
Power Management	ETS 300 328, ETS 30	00 826	
Certifications	Low Voltage Directiv	ve IEC950	



Summary of Changes

UL, CSA, and CE Mark

	Serial Port Profile (SPP) ¹
	Service Discovery Application Profile (SDAP)
	Dial-Up Networking (DUN) ^{1,2}
	Generic Object Exchange Profile (GOEP) ^{1,2}
	Object Push Profile (OPP) ^{1,2}
	File Transfer Profile (FTP)
	Synchronization Profile (SYNC)
Certifications	Hard Copy Cable Replacement (HCRP) ^{1,2}
	Personal Area Networking Profile (PAN) ^{1,2}
Bluetooth Profiles Supported	Human Interface Device Profile (HID) ^{1,2}
	FAX Profile (FAX)
	Basic Imaging Profile (BIP) ²
	Headset Profile (HSP)
	Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)

Bluetooth	V4.1/V4.2 support
feature	

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Broadcom 802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo

Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n

• 2.402 – 2.482 GHz



Summary of Changes

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a

	 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)
Antenna Structure	2 transmit; 2 receive (2x2)
Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
Modulation	Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)



Roaming	IEEE 802.11 compliant roaming between band Access Points
Output Power ² Power Consumption	 802.11b : +16dBm minimum 802.11g : +14dBm minimum 802.11a : +14dBm minimum 802.11n HT20(2.4GHz) : +13dBm minimum 802.11n HT40(2.4GHz) : +13dBm minimum 802.11n HT40(5GHz) : +12dBm minimum
	Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 60 mW (WLAN unassociated)
	Radio disabled: 30 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³ Antenna type	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -86dBm maximum 802.11a, 54Mbps : -72dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm
	Or Type 1630 : 2.3 x 16.0 x 30.0 mm
Weight	Type 2230 : 2.8g
	Or



Summary of Changes

	Туре 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non- condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber - Radio OFF; LED White - Radio ON	

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification	4.0+EDR Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	79 (1 MHz) available channels			
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps			
	Synchronous Conne	ction Oriented links	s up to 3, 64 kbps, voi	ce channels
	Asynchronous Conne asymmetric or 1306		178.1 kbps/177.1 kbp	S
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of +4 dBm for BR and EDR.			
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER	
	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	



	8DPSK	-80 dBm	-70 dBm	
Power Consumption	L Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1	7 mW		
Range	Up to 33 ft (10 m)			
Electrical Interface	USB 2.0 compliant			
Bluetooth Software Supported	Microsoft Windows Bluetooth Software			
Link Topology				
Electrical Interface	Point to Point, Multi	point Pico Nets up	to 7 slaves	
Bluetooth Software Supported	Full support of Blue	tooth Security Prov	visions	
Security				
Power Management	Microsoft Windows	ACPI, and USB Bus S	Support	
Power Management	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff			
Certifications				
Security	All necessary regulatory approvals for supported countries, including:			
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249			
Bluetooth Profiles Supported				
Power Management	ETS 300 328, ETS 300 826			
Certifications	Low Voltage Directiv	ve IEC950		
	UL, CSA, and CE Mar	k		
Certifications Bluetooth Profiles Supported	Serial Port Profile (S Service Discovery A) Dial-Up Networking Generic Object Exch. Object Push Profile File Transfer Profile Synchronization Pro Hard Copy Cable Rep Personal Area Netw Human Interface De	oplication Profile (S (DUN) ^{1,2} ange Profile (GOEP (OPP) ^{1,2} (FTP) ofile (SYNC) olacement (HCRP) ^{1,} orking Profile (PAN)1,2 2)1,2	



FAX Profile (FAX) Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

Broadcom 802.11b/g/n (1x1) WiFi and Bluetooth® 4.0 Combo

Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
Data Rates Modulation	 2.402 – 2.482 GHz Note: The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels. 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 07, (20MHz) Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM,
Security ¹ Network Architecture Models	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points



Output Power ² Power Consumption	 802.11b : +16dBm minimum 802.11g : +14dBm minimum 802.11n HT20(2.4GHz) : +13dBm minimum 802.11n HT40(2.4GHz) : +13dBm minimum 802.11n HT20(5GHz) : +12dBm minimum 802.11n HT40(5GHz) : +12dBm minimum
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11n, MCS07 : -69dBm maximum
	802.11n, MCS15 : -66dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement)
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm
	Or Type 1630 : 2.3 x 16.0 x 30.0 mm
Weight	Type 2230 : 2.8g
	Or



Summary of Changes

	Туре 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	

- 4. Check latest software/driver release for updates on supported security features.
- 5. Maximum output power may vary by country according to local regulations.
- 6. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification	4.0+EDR Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	79 (1 MHz) available channels			
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps			
	Synchronous Conne	ction Oriented links	s up to 3, 64 kbps, voi	ce channels
	Asynchronous Conne asymmetric or 1306		178.1 kbps/177.1 kbp	S
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of +4 dBm for BR and EDR.			
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER	
	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	

-80 dBm

-70 dBm



8DPSK

Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW	
Range	Up to 33 ft (10 m)	
Electrical Interface	USB 2.0 compliant	
Bluetooth Software Supported	Microsoft Windows Bluetooth Software	
Link Topology		
Electrical Interface	Point to Point, Multipoint Pico Nets up to 7 slaves	
Bluetooth Software Supported	Full support of Bluetooth Security Provisions	
Security		
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Power Management	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff	
Certifications		
Security	All necessary regulatory approvals for supported countries, including:	
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Bluetooth Profiles Supported		
Power Management	ETS 300 328, ETS 300 826	
Certifications	Low Voltage Directive IEC950	
	UL, CSA, and CE Mark	
Certifications Bluetooth Profiles Supported	Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP) ²	



Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

Realtek 802.11b/g/n (1x1) Wi-Fi

Wireless LAN Standards	IEEE 802.11b IEEE 802.11g
	IEEE 802.11n
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	 2.402 – 2.482 GHz Note: The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 07, (20MHz)
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM,
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware
	 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite
Network Architecture	WAPI Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	 802.11b : +16dBm minimum 802.11g : +14dBm minimum



Not all configuration components are available in all regions/countries. Americas – HP ProBook 645 & 655 G2 – November 2016 - c04912055

Summary of Changes

Power Consumption	 802.11n HT20(2.4GHz) : +13dBm minimum 802.11n HT40(2.4GHz) : +13dBm minimum 802.11n HT20(5GHz) : +12dBm minimum 802.11n HT40(5GHz) : +12dBm minimum Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 60 mW (WLAN unassociated)
	Radio disabled: 30 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum
	802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11n, MCS07 : -69dBm maximum
	802.11n, MCS15 : -66dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement)
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm
	Or Type 1630 : 2.3 x 16.0 x 30.0 mm
Weight	Туре 2230 : 2.8g
	Or
	Type 1630 : 2g



Not all configuration components are available in all regions/countries. Americas – HP ProBook 645 & 655 G2 – November 2016 - c04912055

Summary of Changes

Operating Voltage	3.3v +/- 9%	
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Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – I	Radio ON

- 7. Check latest software/driver release for updates on supported security features.
- 8. Maximum output power may vary by country according to local regulations.
- 9. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification	4.0+EDR Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	79 (1 MHz) available channels			
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	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels			
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric			
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of +4 dBm for BR and EDR.			
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER	
	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	
	8DPSK	-80 dBm	-70 dBm	



Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW	
Range	Up to 33 ft (10 m)	
Electrical Interface	USB 2.0 compliant	
Bluetooth Software Supported	Microsoft Windows Bluetooth Software	
Link Topology		
Electrical Interface	Point to Point, Multipoint Pico Nets up to 7 slaves	
Bluetooth Software Supported	Full support of Bluetooth Security Provisions	
Security		
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Power Management	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff	
Certifications		
Security	All necessary regulatory approvals for supported countries, including:	
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Bluetooth Profiles Supported		
Power Management	ETS 300 328, ETS 300 826	
Certifications	Low Voltage Directive IEC950	
	UL, CSA, and CE Mark	
Certifications Bluetooth Profiles Supported	Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP) ²	



Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

ENVIRONMENTAL TBD

COUNTRY OF ORIGIN

China

Туре	Description	Part Number
Docking	HP 3001pr USB 3.0 Port Replicator	F3S42AA
	HP 3005pr USB 3.0 Port Replicator	H1L08AA#xxx
	HP Display and Notebook Stand II	E8G00AA#xxx
	Universal Port Replicator	E6D70AA#xxx
	HP UltraSlim Docking Station	D9Y32AA#xxx
Input/Output/Audio	HP USB Travel Mouse	G1K28AA#xxx
	HP Ultrathin Wireless Mouse SE	L9V77AA
	HP Ultrathin Wireless Mouse	L9V78AA
	HP Stereo USB Headset	T1A67AA
	DisplayPort to HDMI Adapter	F3W43AA
	DisplayPort to DVI Adapter	F7W96AA
Power	HP 45W Smart AC Adapter (4.5mm)	H6Y88AA#xxx
	HP 65W Smart AC Adapter	H6Y89AA#xxx
Storage - External Storage	HP USB External DVDRW Drive	F2B56AA
Security	HP UltraSlim Keyed Cable Lock	H4D73AA
	HP USB Smart Card Reader	F6V67AA



Not all configuration components are available in all regions/countries. Americas – HP ProBook 645 & 655 G2 – November 2016 - c04912055

	HP Docking Station Cable Lock	AU656AA#XXX
Display	HP ProDisplay P232	K7X31AA
	HP ProDisplay P222va	K7X30AA
	HP ProDisplay P222c	L4J08AA

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